STF17N80K5



N-channel 800 V, 0.29 Ω typ., 14 A MDmesh™ K5 Power MOSFET in a TO-220FP package

Datasheet - production data

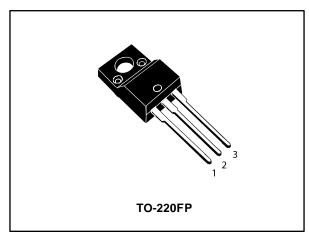
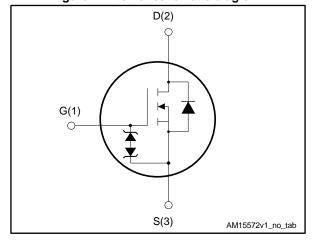


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	Ι _D
STF17N80K5	800 V	0.34 Ω	14 A

- Industry's lowest R_{DS(on)} x area
- Industry's best figure of merit (FoM)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STF17N80K5	17N80K5	TO-220FP	Tube

Contents STF17N80K5

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STF17N80K5 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{GS}	Gate-source voltage	± 30	V
$I_D^{(1)}$	Drain current (continuous) at T _C = 25 °C	14	Α
$I_D^{(1)}$	Drain current (continuous) at T _C = 100 °C	9	Α
I _{DM} ⁽²⁾	Drain current (pulsed)	56	Α
P _{TOT}	Total dissipation at $T_C = 25$ °C	30	W
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t=1 s; T_c =25 °C)	2500	V
dv/dt (3)	Peak diode recovery voltage slope	4.5	\
dv/dt (4)	MOSFET dv/dt ruggedness	50	V/ns
TJ	Operating junction temperature range	EE to 150	°C
T _{stg}	Storage temperature range	- 55 to 150	

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit	
R _{thj-case}	R _{thj-case} Thermal resistance junction-case			
R _{thj-amb} Thermal resistance junction-ambient		62.5	°C/W	

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR} Avalanche current, repetitive or not repetitive (pulse width limited by T _{jmax})		4.7	Α
E _{AS}	Single pulse avalanche energy (starting Tj = 25 °C, $I_D = I_{AR}$, $V_{DD} = 50 \text{ V}$)	340	mJ

⁽¹⁾Limited by maximum junction temperature.

⁽²⁾Pulse width limited by safe operating area

 $^{^{(3)}}$ I_{SD} \leq 14 A, di/dt 100 A/ μ s; V_{DS} peak < V_{(BR)DSS},V_{DD}= 400 V

 $^{^{(4)}}V_{DS} \le 640 \text{ V}$

Electrical characteristics STF17N80K5

2 Electrical characteristics

T_C = 25 °C unless otherwise specified

Table 5: On/off-state

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_{D} = 1 \text{ mA}$	800			٧
		$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$			1	μΑ
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$ $T_{C} = 125 \text{ °C}$			50	μΑ
I _{GSS}	Gate body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$			±10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DD} = V_{GS}, I_D = 250 \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 7 \text{ A}$		0.29	0.34	Ω

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	866	1	pF
Coss	Output capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$ $V_{GS} = 0 \text{ V}$	-	64	ı	pF
C_{rss}	Reverse transfer capacitance	VG3 - 0 V	-	0.42	-	pF
C _{o(tr)} ⁽¹⁾	Equivalent capacitance time related	V _{DS} = 0 to 640 V,	-	142	1	pF
C _{o(er)} ⁽²⁾	Equivalent capacitance energy related	$V_{GS} = 0 V$	-	51	ı	pF
R_g	Intrinsic gate resistance	$f = 1 \text{ MHz}$, $I_D = 0 \text{ A}$	-	5	ı	Ω
Q_g	Total gate charge	$V_{DD} = 640 \text{ V}, I_D = 14 \text{ A}$	-	26	-	nC
Q_{gs}	Gate-source charge	V _{GS} = 10 V	-	7.2	-	nC
Q_{gd}	Q _{gd} Gate-drain charge See (Figure 15: "Te circuit for gate charge behavior")		-	15.2	-	nC

Notes:

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V_{DD} = 400 V, I_D =7 A, R_G = 4.7 Ω	-	14.8	-	ns
t _r	Rise time	V _{GS} = 10 V	-	10.8	-	ns
t _{d(off)}	Turn-off delay time	See (Figure 14: "Test circuit for resistive load switching times" and		84.3	1	ns
t _f	Fall time	Figure 19: "Switching time waveform")	-	10.1	1	ns

 $^{^{(1)}}$ Time related is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

 $^{^{(2)}}$ Energy related is defined as a constant equivalent capacitance giving the same stored energy as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		14	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		56	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 14 A, V _{GS} = 0 V	-		1.6	V
t _{rr}	Reverse recovery time	I _{SD} = 14 A, di/dt = 100 A/μs,V _{DD} = 60 V See Figure 16: "Test circuit for inductive load switching and diode recovery times"	-	439		ns
Q _{rr}	Reverrse recovery charge		-	6.37		μC
I _{RRM}	Reverse recovery current		ı	29		Α
t _{rr}	Reverse recovery time	$I_{SD} = 14 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s V}_{DD}$	-	626		ns
Qrr	Reverse recovery charge	= 60 V, T _j = 150 °C See <i>Figure 16: "Test circuit for</i>	-	8.36		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times"	-	26.7		Α

Notes:

Table 9: Gate-source Zener diode

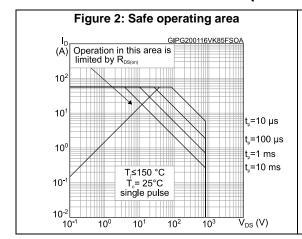
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)GSO}	Gate-source breakdown voltage	I_{GS} = ± 1mA, I_{D} = 0 A	30	-	-	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

⁽¹⁾Pulse width limited by safe operating area

 $^{^{(2)}\}text{Pulsed:}$ pulse duration = 300 $\mu\text{s},$ duty cycle 1.5%

2.2 Electrical characteristics (curves)



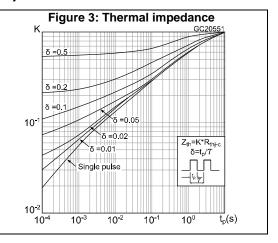


Figure 4: Output characteristics

(A)

V_{GS} = 10 V

32

V_{GS} = 11 V

V_{GS} = 9 V

24

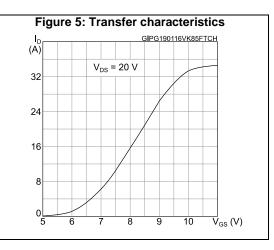
V_{GS} = 8 V

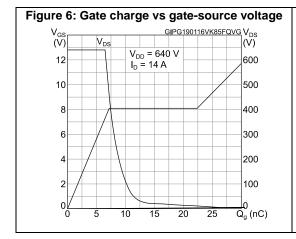
V_{GS} = 7 V

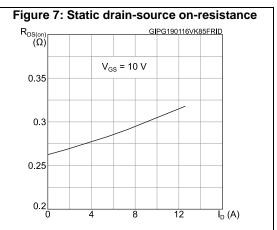
V_{GS} = 6 V

0

4 8 12 16 V_{DS} (V)







STF17N80K5 Electrical characteristics

Figure 8: Capacitance variations

C
(pF)

103

102

Coss

101

f = 1 MHz

1001

10-1

10-1

10-1

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Figure 10: Normalized on-resistance vs temperature

R_{DS(on)} GIPG200116VK85FRON (norm.)

2.6

2.2

1.8

1.4

1.0

0.6

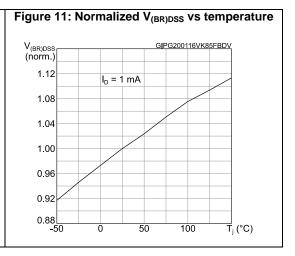
0.2

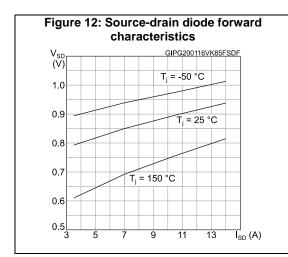
-50

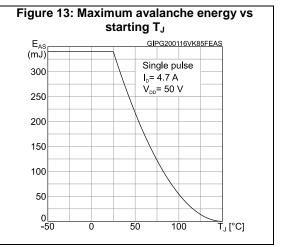
0 50

100

T_j (°C)

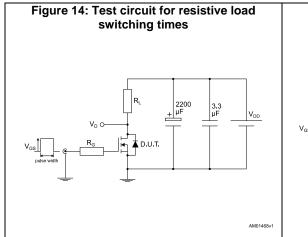






Test circuits STF17N80K5

3 Test circuits



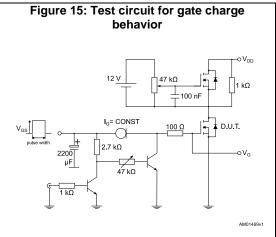
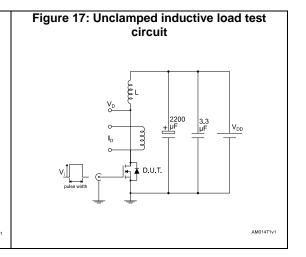
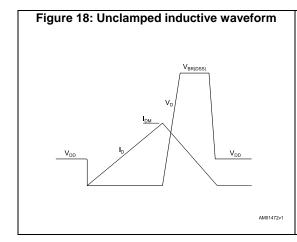
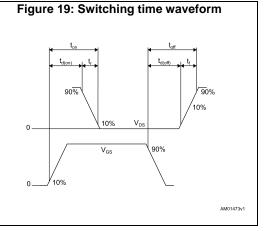


Figure 16: Test circuit for inductive load switching and diode recovery times







STF17N80K5 Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 TO-220 FP package information

Figure 20: TO-220FP package outline

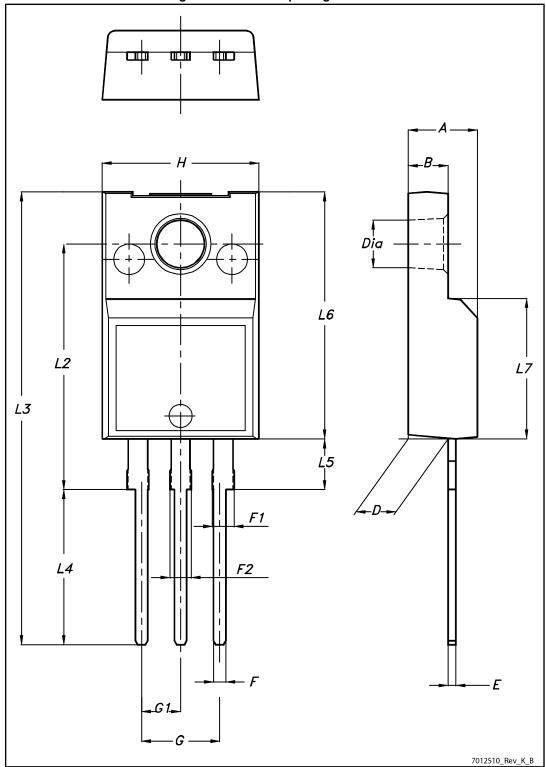


Table 10: TO-220FP package mechanical data

Di	mm			
Dim.	Min.	Тур.	Max.	
А	4.4		4.6	
В	2.5		2.7	
D	2.5		2.75	
Е	0.45		0.7	
F	0.75		1	
F1	1.15		1.70	
F2	1.15		1.70	
G	4.95		5.2	
G1	2.4		2.7	
Н	10		10.4	
L2		16		
L3	28.6		30.6	
L4	9.8		10.6	
L5	2.9		3.6	
L6	15.9		16.4	
L7	9		9.3	
Dia	3		3.2	

Revision history STF17N80K5

5 Revision history

Table 11: Document revision history

Date	Revision	Changes
31-Mar-2015	1	First release.
20-Jan-2016	2	Modified: Table 4: "Avalanche characteristics", Table 6: "Dynamic", Table 7: "Switching times", and Table 8: "Source-drain diode" Added: Section 3.1: "Electrical characteristics (curves)" Minor text changes

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